

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
JUNICHI TAKEYA	03/17/2021
SHUNICHIRO WATANABE	03/30/2021
YU YAMASHITA	03/31/2021
KEITA YAEGASHI	04/13/2021
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<b>State/Country:</b>	JAPAN
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	17272585
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
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<b>SIGNATURE:</b>	/EMILY GOYETTE/
<b>DATE SIGNED:</b>	05/14/2021
<b>Total Attachments: 5</b>	
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**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR(S) of the sum of One Dollar (\$1.00) and for other good and valuable consideration, the receipt of which is hereby acknowledged, by this document

## ASSIGNOR(S):

Name	Address
Junichi TAKEYA	c/o The University of Tokyo, 3-1, Hongo 7-chome, Bunkyo-ku, Tokyo 1138654 Japan
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assigns and transfers to:

## ASSIGNEE:

Name	Address
The University of Tokyo	3-1, Hongo 7-chome, Bunkyo-ku, Tokyo 1138654 Japan

the entire right, title and interest in and to the invention entitled:

ORGANIC SEMICONDUCTOR ELEMENT, STRAIN SENSOR, VIBRATION SENSOR,  
AND MANUFACTURING METHOD FOR ORGANIC SEMICONDUCTOR ELEMENT

and which is found in:

- ☐ the U.S. patent application filed with this assignment document
- ☐ U.S. patent application no., filed on
- ☒ International patent application no. PCT/JP2019/034672, filed on September 3, 2019
- ☐ U.S. patent no. , issued

and, in and to

- all patent applications filed and letters patent obtained for the invention, whether foreign and domestic, and all continuations, continuation-in-part divisions, renewals, reissues, re-examinations, or substitutes of any such patent or patent application; and any patents and patent applications to which any such patent or patent application claims priority;
- all rights to any legal equivalent thereof in a foreign country such as patents of addition, utility models, patents of importation, revalidation patents and inventor certificates;

- the right to apply for patents and inventor certificates relating to the invention, and the right to claim priority to all applications throughout the world in respect of the invention; and
- the right to sue and recover any and all damages and profits, and any and all other remedies, for past, present, or future infringements of patents directed to the invention.

ASSIGNOR(S) authorizes ASSIGNEE or its legal representative to insert in this instrument the filing date, serial number, and any other information that may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office or any other domestic or foreign government entity for the recordation of this document.

ASSIGNOR(S) warrants and agrees that:

- no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;
- upon request, ASSIGNOR(S) will promptly provide ASSIGNEE with all pertinent facts and documents relating to the invention as may be known and accessible to ASSIGNOR(S);
- ASSIGNOR(S) will, at ASSIGNEE'S expense, testify as to the same in any interference, litigation or proceeding related to the invention; and
- ASSIGNOR(S) will promptly execute and deliver to ASSIGNEE, its assigns or its legal representatives, without further or additional consideration, any and all papers, instruments or affidavits required, render all necessary assistance, and do such additional acts as ASSIGNEE or its successors or assigns may deem necessary or desirable, to apply for, obtain, maintain, issue and enforce any resulting patents or patent applications.


ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks and any foreign counterpart to issue any and all letters patent for the invention to ASSIGNEE, for ASSIGNEE'S sole use and benefit, and for the use and benefit of ASSIGNEE'S successors and assigns, to the full end of the term for which such patent may be granted.

ASSIGNOR(S) agree that this document shall bind and inure to the benefit of the heirs, assigns and legal representatives of both ASSIGNOR(S) and ASSIGNEE.

Date: 3/17/2021

Signature:   
Junichi TAKEYA

Date: March 30, 2021

Signature:   
Shunichiro WATANABE

Date: \_\_\_\_\_

Signature: \_\_\_\_\_  
Yu YAMASHITA

Date: \_\_\_\_\_

Signature: \_\_\_\_\_  
Keita YAEHASHI

Date: \_\_\_\_\_

Signature: \_\_\_\_\_  
Shunichiro WATANABE

Date: March 31, 2021

Signature: Yu Yamashita  
Yu YAMASHITA

Date: \_\_\_\_\_

Signature: \_\_\_\_\_  
Keita YAEHASHI

Date: \_\_\_\_\_

Signature: \_\_\_\_\_  
Shunichiro WATANABE

Date: \_\_\_\_\_

Signature: \_\_\_\_\_  
Yu YAMASHITA

Date: April 13, 2021

Signature: Keita Yaegashi  
Keita YAEHASHI